



**THE DATASHEET OF**  
**178216-2**

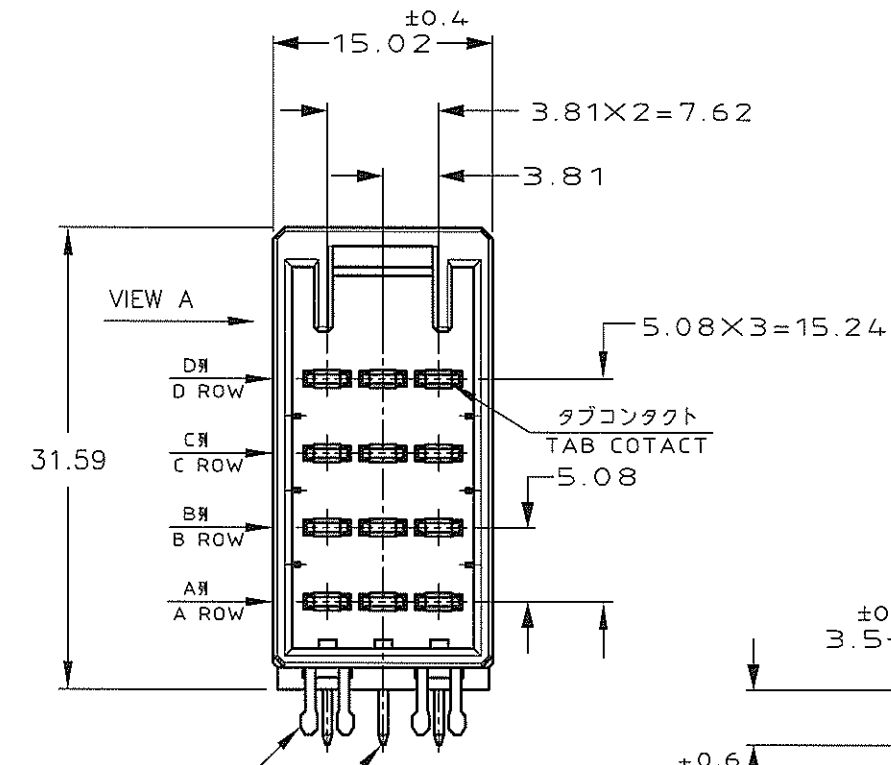


NUMBER 178216

METRIC

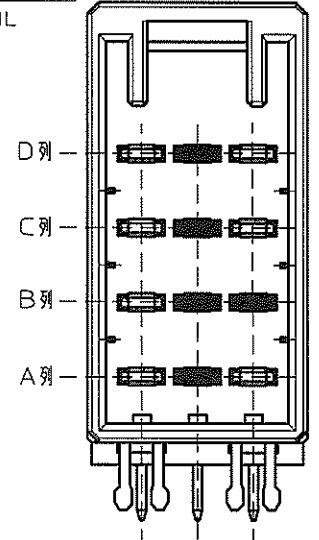
PRINT DIST DIMENSIONS IN MM. DO NOT SCALE PRINT

		178216-5
		178216-3
		178216-2
(FINISH)		製品番号 (PART NO)

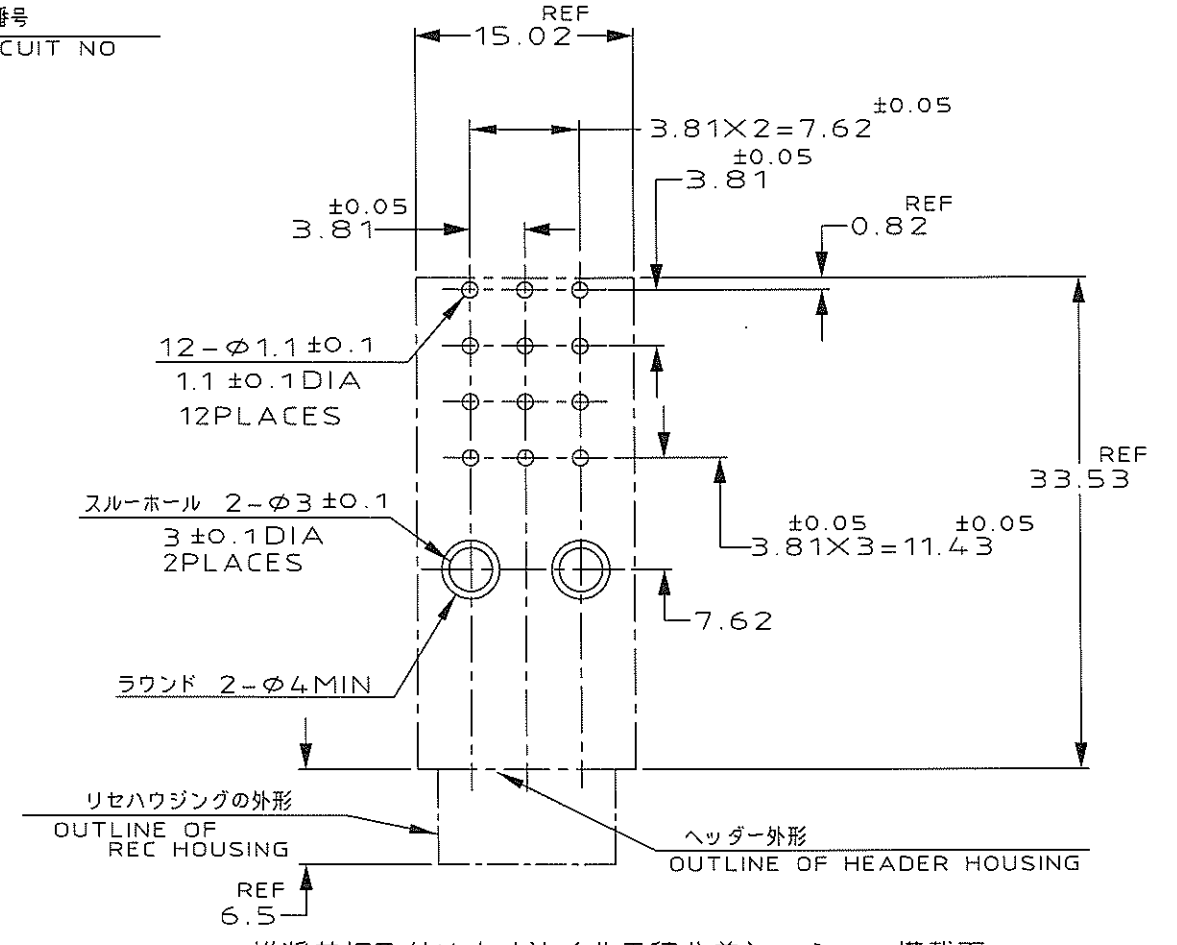
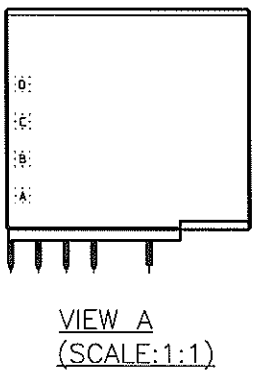
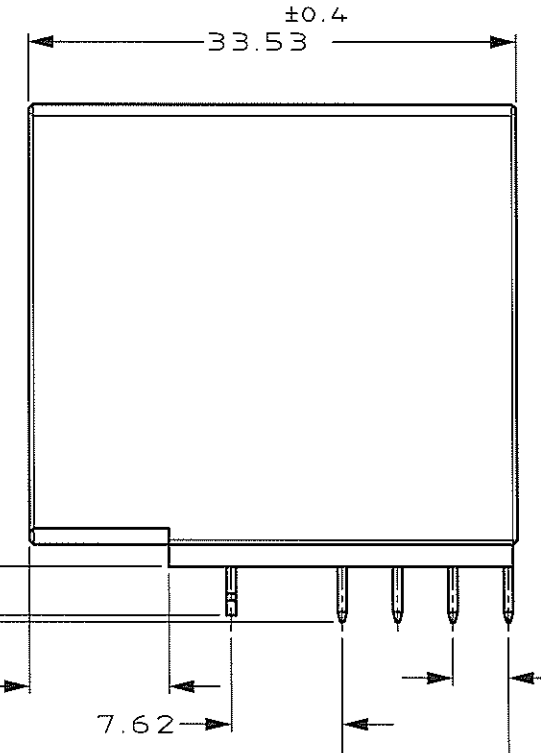
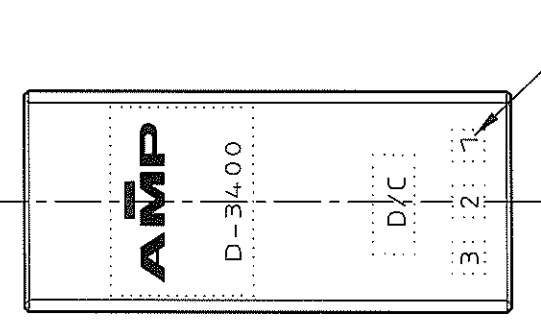


リテンションレグ RETENTION LEG

コンタクト半田付け部 CONTACT TAIL



		A-2	1-178216-2
		B-2	2-178216-2
		C-2	3-178216-2
		D-2	4-178216-2
		B-3	5-178216-2
(FINISH)	ピン抜き箇所 (POINT OF PULLING)	製品番号 (PART NO)	



推奨基板取付け穴寸法 (非累積公差) コネクタ搭載面

RECOMMEND PC BOARD HOLE PATTERN (NOT ACCUMULATE TOLERANCE)

PC BOARD THICKNESS: 1.6 ±0.1

注記

- 1 材料 ハウジング: ガラス入り熱可塑性ポリエステル樹脂  
コンタクト: 銅合金  
リテンションレグ: 銅合金
- 2 めっき (コンタクト接触部): ニッケル下地の上に 0.38 μMIN 金めっき
- 3 めっき (コンタクト接触部): ニッケル下地の上に 0.76 μMIN 金めっき
- 4 めっき (コンタクト全面): ニッケル下地の上に 2.0 μMIN スズめっき
- 5 めっき (リテンションレグとコンタクト半田付け部): ニッケル下地の上に半田めっき
- 6 製品規格: 108-5349
- 7 めっき (リテンションレグとコンタクト半田付け部): ニッケル下地の上にスズめっき

NOTES


- 1 MATERIAL HOUSING: GLASS FIELD POLYESTER  
CONTACT: COPPER ALLOY  
RETENTION LEG: COPPER ALLOY
- 2 FINISH (CONTACT AREA): 0.38 μMIN GOLD PLATED OVER NICKEL
- 3 FINISH (CONTACT AREA): 0.76 μMIN GOLD PLATING OVER NICKEL
- 4 FINISH (CONTACT AREA): 2.0 μMIN TIN PLATING OVER NICKEL
- 5 FINISH (RETENTION LEG AND CONTACT TAIL): TIN LEAD PLATING
- 6 PRODUCT SPEC. 108-5349
- 7 FINISH (RETENTION LEG AND CONTACT TAIL): TIN PLATING

E1	REVISED ECR-07-013273	TS	DM	11/30/97
E	REVISED (FJD0-0039-03)	TS	SM	2/JUN/03
D	REVISED (FJD0-0114-03)	TS	SM	25/APR/03
C1	REVISED (FJ00-2716-01)	TS	SM	11/26/01
C	REVISED (FJ00-1336-98)	MH	NM	7/14/98
B	REVISED (FJ00-0775-98)	MH	NM	6/15/98
A	REDRAWN (FJ00-2183-95)	KI	SM	3/23/95
LTR	変更 (REVISION RECORD)	DR	CHK	DATE

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規格 (WIRE RANGE)		絶縁外径 (INSULATION DIA.)		名称 (NAME) ダイナミック D-3400 12P (H) ヘッダーアセンブリー DYNAMIC D-3400 12P (H) HDR ASS'Y	
材料 (MATERIAL) 注記参照		仕上 (FINISH) 注記参照		一般公差 (GENERAL TOLERANCE)	
SEE NOTES		SEE NOTES		A3 J C=178216	
DR. M.HIGO 15/JUN/98		DE. M.HIGO 15/JUN/98		100% 300% ±0.3 300% 100% ±0.4 A B ±0.45 A B ±0.3	
CHK. N.MATSUBARA 15/JUN/98		APP. I.HASEGAWA 15/JUN/98		R (SCALE) 2-1 REV. E1 SHEET 1 OF 1	

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 [TE Connectivity](#) Information

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